

UTC UNISONIC TECHNOLOGIES CO., LTD

# 3N60-TA

# Power MOSFET

# 3A, 600V N-CHANNEL **POWER MOSFET**

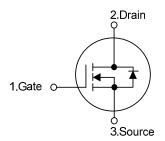
### DESCRIPTION

The UTC 3N60-TA is a high voltage power MOSFET designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and high rugged avalanche characteristics. This power MOSFET is usually used in high speed switching applications of switching power supplies and adaptors.

### **FEATURES**

- \*  $R_{DS(ON)}$  < 3.3 $\Omega$  @ V<sub>GS</sub>=10V, I<sub>D</sub>=1.5A
- \* Fast switching capability
- \* Avalanche energy tested
- \* Improved dv/dt capability, high ruggedness

#### **SYMBOL**



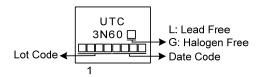
#### **ORDERING INFORMATION**

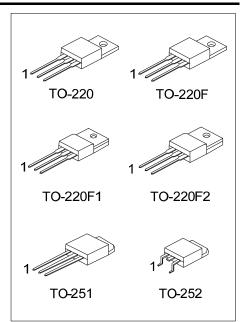
Ordering Number		Dookogo	Pin Assignment			Packing
Lead Free	Halogen Free	Package	1	2	3	Facking
3N60L-TA3-T	3N60G-TA3-T	TO-220	G	D	S	Tube
3N60L-TF1-T	3N60G-TF1-T	TO-220F1	G	D	S	Tube
3N60L-TF2-T	3N60G-TF2-T	TO-220F2	G	D	S	Tube
3N60L-TF3-T	3N60G-TF3-T	TO-220F	G	D	S	Tube
3N60L-TM3-T	3N60G-TM3-T	TO-251	G	D	S	Tube
3N60L-TN3-R	3N60G-TN3-R	TO-252	G	D	S	Tape Reel
Note <sup>.</sup> Pin Assignment <sup>.</sup> G <sup>.</sup> (	Sate D: Drain S: Source					·

'in Assignment: G: Gate D: Drain

3N60G-TA3-T (1)Packing Type (2)Package Type (3)Green Package	<ul> <li>(1) T: Tube, R: Tape Reel</li> <li>(2) TA3: TO-220, TF3: TO-220F, TF1: TO-220F1 TF2: TO-220F2, TM3: TO-251, TN3: TO-252</li> <li>(3) G: Halogen Free and Lead Free, L: Lead Free</li> </ul>
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#### MARKING





### ■ ABSOLUTE MAXIMUM RATINGS (T<sub>c</sub> = 25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT	
Drain-Source Voltage		V <sub>DSS</sub> 600		V	
Gate-Source Voltage		V <sub>GSS</sub>	±30	V	
Continuous Drain Current		I <sub>D</sub>	3	А	
Pulsed Drain Current (Not	e 2)	I <sub>DM</sub> 6		А	
Avalanche Energy	Single Pulsed (Note 3)	E <sub>AS</sub>	101	mJ	
Peak Diode Recovery dv/o	dt (Note 4)	dv/dt	3.3	V/ns	
	TO-220		75	W	
Power Dissipation	te 2) Single Pulsed (Note 3 dt (Note 4)		P <sub>D</sub>	34	W
	TO-251/TO-252		45	W	
Junction Temperature		TJ +150		°C	
Storage Temperature		T <sub>STG</sub>	-55 ~ +150	°C	

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating: Pulse width limited by maximum junction temperature.

3. L = 10mH, I<sub>AS</sub> = 4.5A, V<sub>DD</sub> = 50V, R<sub>G</sub> = 25  $\Omega$ , Starting T<sub>J</sub> = 25°C

4.  $I_{SD} \le 3.0A$ , di/dt  $\le 200A/\mu s$ ,  $V_{DD} \le BV_{DSS}$ , Starting  $T_J = 25^{\circ}C$ 

### THERMAL DATA

PARAMETER		SYMBOL	RATING	UNIT
Junction to Ambient	TO-220/TO-220F TO-220F1/TO-220F2	θ <sub>JA</sub>	62.5	°C/W
	TO-251/TO-252		110 (Note)	°C/W
	TO-220		1.67	°C/W
Junction to Case	TO-220F/TO-220F1 TO-220F2	$\theta_{\rm JC}$	3.68	°C/W
	TO-251/TO-252		2.78 (Note)	°C/W

Note: The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper.



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PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV <sub>DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = 250µA	600			V
Drain-Source Leakage Current		I <sub>DSS</sub>	$V_{DS} = 600V, V_{GS} = 0V$			10	μA
Gate- Source Leakage Current	Forward	I <sub>GSS</sub>	$V_{GS}$ = 30V, $V_{DS}$ = 0V			100	nA
	Reverse	IGSS	$V_{GS}$ = -30V, $V_{DS}$ = 0V			46 3.4 10	nA
ON CHARACTERISTICS				-		_	
Gate Threshold Voltage	Gate Threshold Voltage		$V_{DS} = V_{GS}, I_D = 250 \mu A$	2.0		4.0	V
Static Drain-Source On-State Resis	stance	R <sub>DS(ON)</sub>	V <sub>GS</sub> = 10V, I <sub>D</sub> = 1.5A			3.3	Ω
DYNAMIC CHARACTERISTICS							
Input Capacitance		CISS			392		pF
Output Capacitance	put Capacitance		V <sub>DS</sub> =25V, V <sub>GS</sub> =0V, f=1.0MHz		46		pF
Reverse Transfer Capacitance		C <sub>RSS</sub>			3.4		pF
SWITCHING CHARACTERISTICS	6						
Total Gate Charge (Note 1)		$Q_{G}$	V <sub>DS</sub> =100V, V <sub>GS</sub> =10V, I <sub>D</sub> =2A		10		nC
Gate-Source Charge		$Q_{GS}$	$I_{G}$ =1mA (Note 1, 2)		3.4		nC
Gate-Drain Charge		$Q_{GD}$			1.8		nC
Turn-On Delay Time (Note 1)		t <sub>D(ON)</sub>			33		ns
Turn-On Rise Time		t <sub>R</sub>	V <sub>DS</sub> =30V, V <sub>GS</sub> =10V, I <sub>D</sub> =0.5A,		23		ns
Turn-Off Delay Time		t <sub>D(OFF)</sub>	R <sub>G</sub> =25Ω (Note 1, 2)         110           52			ns	
Turn-Off Fall Time		t⊢			ns		
DRAIN-SOURCE DIODE CHARAG	CTERISTICS	AND MAXI	MUM RATINGS				
Maximum Body-Diode Continuous	Current	ls				3	Α
Maximum Body-Diode Pulsed Curr	ent	I <sub>SM</sub>				6	Α
Drain-Source Diode Forward Volta	ge (Note 1)	V <sub>SD</sub>	I <sub>S</sub> =3.0A , V <sub>GS</sub> =0V			1.4	V
Reverse Recovery Time (Note 1)		t <sub>rr</sub>	I <sub>S</sub> =3.0A , V <sub>GS</sub> =0V		264		ns
Reverse Recovery Charge	Reverse Recovery Charge		di/dt=100A/µs		1.6		μC

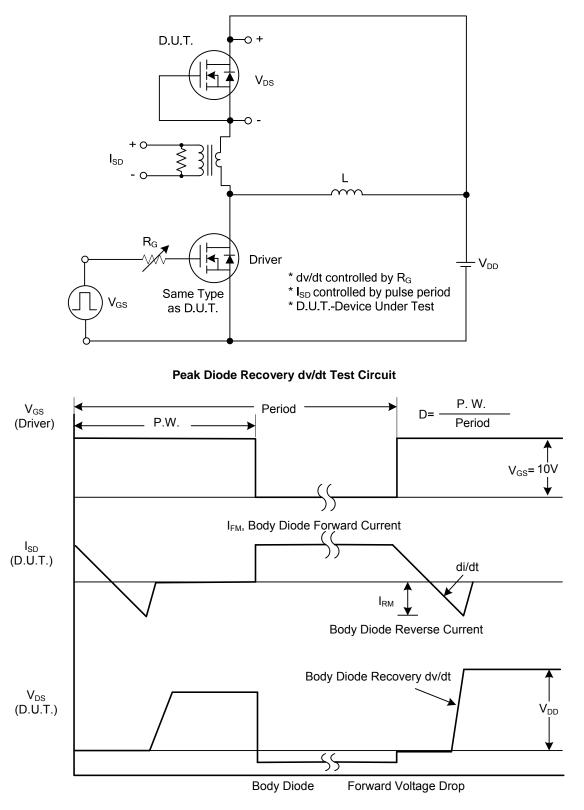
### ■ ELECTRICAL CHARACTERISTICS (T<sub>J</sub>=25°C, unless otherwise specified)

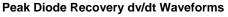
Notes: 1. Pulse Test: Pulse width  $\leq$  300µs, Duty cycle  $\leq$  2%.

2. Essentially independent of operating temperature.



## TEST CIRCUITS AND WAVEFORMS

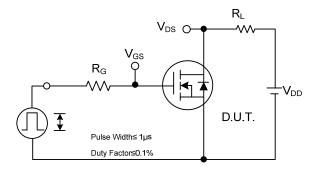




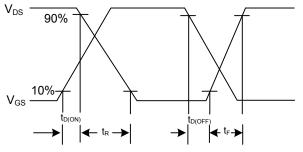


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## TEST CIRCUITS AND WAVEFORMS

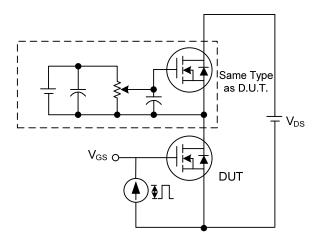




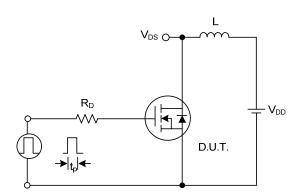


Switching Waveforms

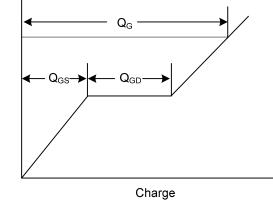
 $V_{\text{GS}}$ 



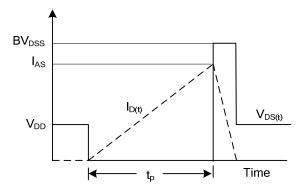
Gate Charge Test Circuit



**Unclamped Inductive Switching Test Circuit** 







**Unclamped Inductive Switching Waveforms** 



10

CISS

coss

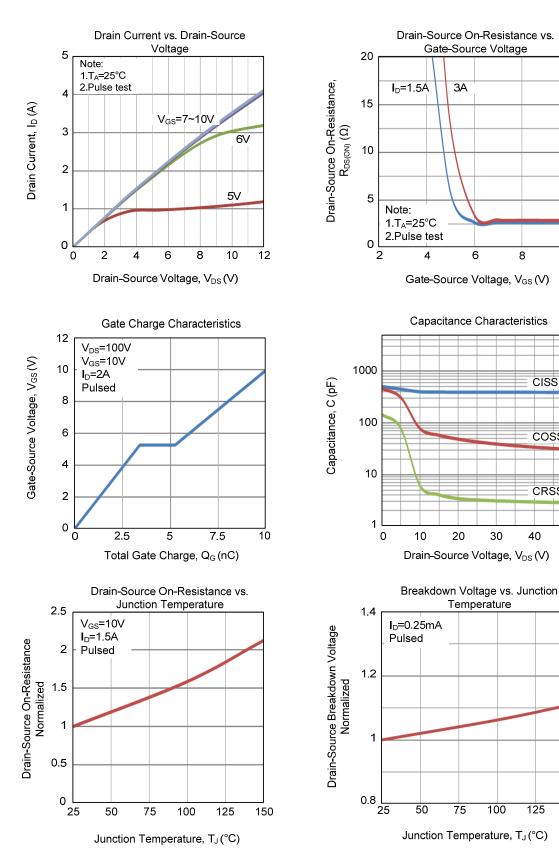
CRSS

50

40

125

## **TYPICAL CHARACTERISTICS**

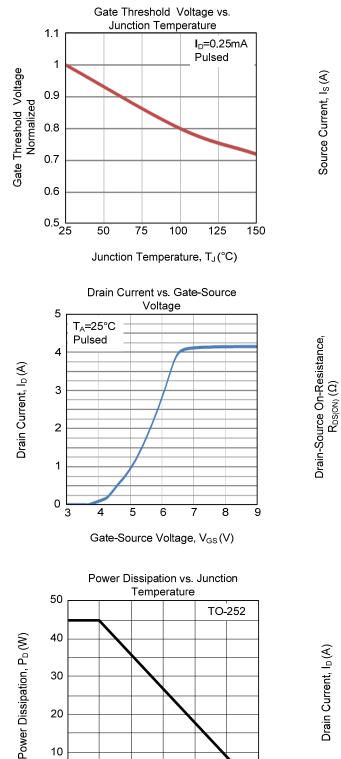


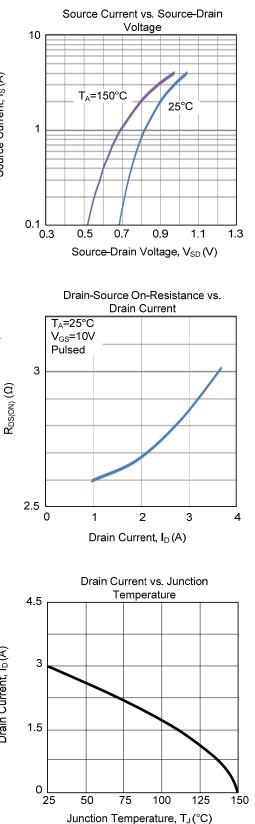


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## ■ TYPICAL CHARACTERISTICS (Cont.)





50

75

Junction Temperature, T<sub>J</sub> (°C)

100

125

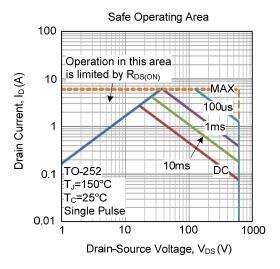
150

0∟ 0

25

# 3N60-TA

# ■ TYPICAL CHARACTERISTICS (Cont.)



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